Ball / Land Grid Array Sockets **Knob Lock Type**

(patents pending)

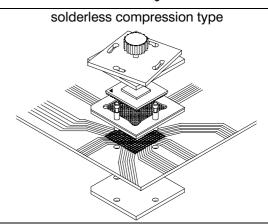


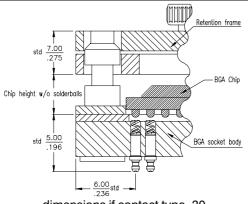
E-tec is now the leading BGA socket manufacturer.

Sockets range from 19 x 19 upwards contacts with even larger parts currently in design. Some of the existing patterns are shown on the following pages, many more exist and your exact requirements can easily be added to our extensive product library. The SMD socket is simply placed and reflowed onto the PCB in the same way as the chip and occupies only a small amount of additional board space. The knob lock socket extends ≈ 6,00 mm beyond the outer ballrow with no fixing holes.

We aim to solve your requirements - many different terminals and configurations are available. Your custom sets our standards!

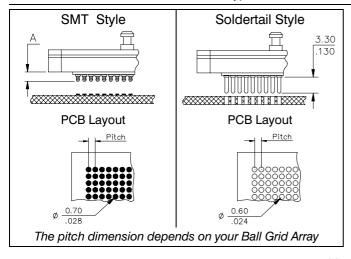
Please note, we will always request the chip data to ensure we offer a compatible socket.





dimensions if contact type 30

SMT and soldertail type



Mechanical data Contact life

Retention System life Solderability

Individual contact force

Material

Insulator

Terminal

Contact

Electrical data Contact resistance

Current rating Insulation resistance at 500V DC Breakdown voltage at 60 Hz

Operating temperature

Specifications

min. 100000 cycles 1000 cycles min.

exceeds MIL-STD-202 Method 208

40 grams max.

Glass Epoxy FR 4

Brass BeCu

< 30 m Ω

1 A max $>10^4 M\Omega$ 1 KV min.

-55°C to +150°C; 220°C for 10 sec.

